



PI74FCT16501T PI74FCT162501T PI74FCT162H501T

Fast CMOS 18-Bit Registered Transceivers

Product Features

Common Features:

- PI74FCT16501T, PI74FCT162501T, and PI74FCT162H501T are high-speed, low power devices with high current drive.
- $V_{CC} = 5V \pm 10\%$
- Hysteresis on all inputs
- Packages available
 - 56-pin 240 mil wide plastic TSSOP (A)
 - 56-pin 300 mil wide plastic SSOP (V)

PI74FCT16501T Features

- High output drive: $I_{OH} = -32\text{ mA}$; $I_{OL} = 64\text{ mA}$
- Power off disable outputs permit “live insertion”
- Typical V_{OLP} (Output Ground Bounce) $< 1.0V$ at $V_{CC} = 5V$, $T_A = 25^\circ C$

PI74FCT162501T Features

- Balanced output drivers: $\pm 24\text{ mA}$
- Reduced system switching noise
- Typical V_{OLP} (Output Ground Bounce) $< 0.6V$ at $V_{CC} = 5V$, $T_A = 25^\circ C$

PI74FCT162H501T Features

- Bus Hold retains last active bus state during 3-state
- Eliminates the need for external pull-up resistors

Product Description

Pericom Semiconductor's PI74FCT series of logic circuits are produced in the Company's advanced 0.6 micron CMOS technology, achieving industry leading speed grades.

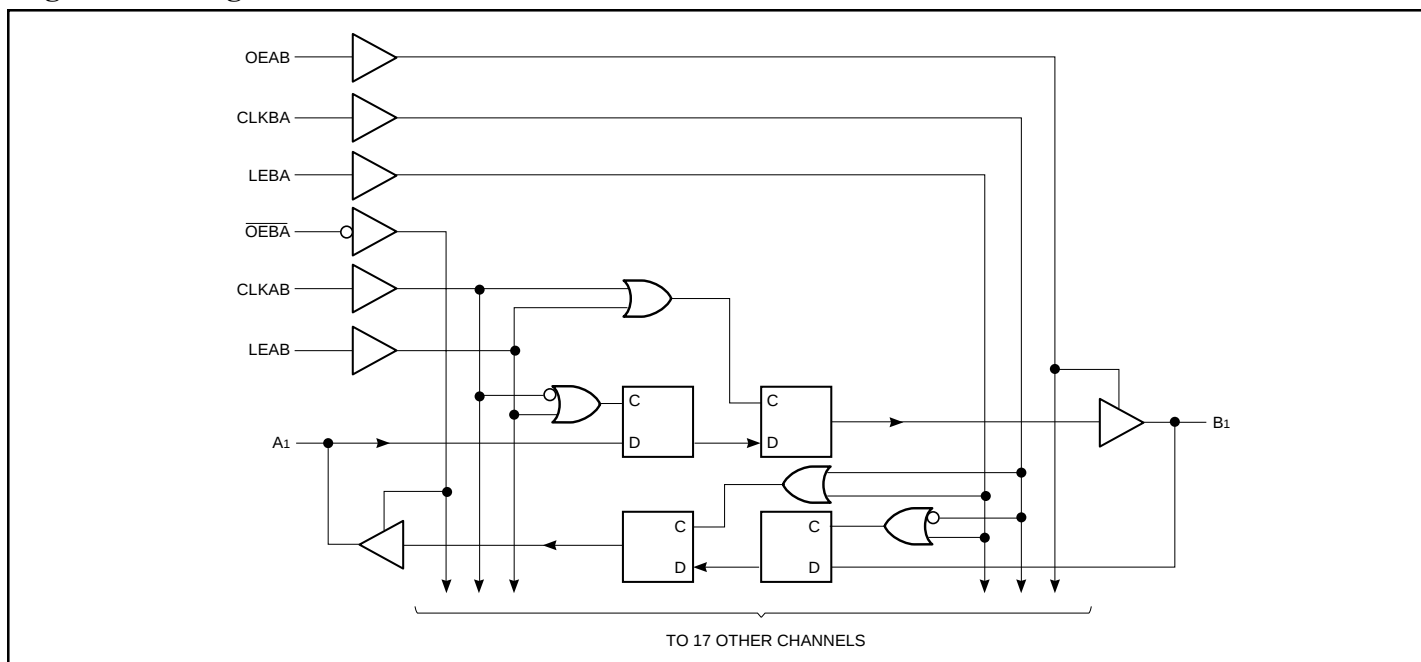
The PI74FCT16501T, PI74FCT162501T, and PI74FCT162H501T are 18-bit registered bus transceivers designed with D-type latches and flip-flops to allow data flow in transparent, latched, and clocked modes. The Output Enable (OEAB and OEBA, Latch Enable (LEAB and LEBA) and Clock (CLKAB and CLKBA) inputs control the data flow in each direction. When LEAB is HIGH, the device operates in transparent mode for A-to-B data flow. When LEAB is LOW, the A data is latched if CLKAB is held at a HIGH or LOW logic level. The A bus data is stored in the latch/flip-flop on the LOW-to-HIGH transition of CLKAB, if LEAB is LOW. OEAB performs the output enable function on the B port. Data flow from B port to A port is similar using OEBA, LEBA and CLKBA. These high-speed, low power devices offer a flow-through organization for ease of board layout.

The PI74FCT16501T output buffers are designed with a Power-Off disable allowing "live insertion" of boards when used as backplane drivers.

The PI74FCT162501T has $\pm 24\text{ mA}$ balanced output drivers. It is designed with current limiting resistors at its outputs to control the output edge rate resulting in lower ground bounce and undershoot. This eliminates the need for external terminating resistors for most interface applications.

The PI74FCT162H501T has “Bus Hold” which retains the input's last state whenever the input goes to high-impedance preventing “floating” inputs and eliminating the need for pull-up/down resistors.

Logic Block Diagram



Product Pin Description

Pin Name	Description
OEAB	A-to-B Output Enable Input
$\overline{\text{OEBA}}$	B-to-A Output Enable Input (Active LOW)
LEAB	A-to-B Latch Enable Input
LEBA	B-to-A Latch Enable Input
CLKAB	A-to-B Clock Input
CLKBA	B-to-A Clock Input
Ax	A-to-B Data Inputs or B-to-A 3-State Outputs ⁽¹⁾
Bx	B-to-A Data Inputs or A-to-B 3-State Outputs ⁽¹⁾
GND	Ground
VCC	Power

Note: 1. For the PI74FCT162H501T, these pins have “Bus Hold.” All other pins are standard, outputs, or I/Os.

Truth Table^(1,4)

Inputs				Outputs
OEAB	LEAB	CLKAB	Ax	Bx
L	X	X	X	Z
H	H	X	L	L
H	H	X	H	H
H	L	↑	L	L
H	L	↑	H	H
H	L	L	X	B ⁽²⁾
H	L	H	X	B ⁽³⁾

Notes:

1. A-to-B data flow is shown. B-to-A data flow is similar but uses $\overline{\text{OEBA}}$, LEBA, and CLKBA.
2. Output level before the indicated steady-state input conditions were established.
3. Output level before the indicated steady-state input conditions were established, provided that CLKAB was LOW before LEAB went LOW.
4. H = High Voltage Level
L = Low Voltage Level
Z = High Impedance
↑ = LOW-to-HIGH Transition

Product Pin Configuration

OEAB	1	56	GND
LEAB	2	55	CLKAB
A0	3	54	B0
GND	4	53	GND
A1	5	52	B1
A2	6	51	B2
VCC	7	50	VCC
A3	8	49	B3
A4	9	48	B4
A5	10	47	B5
GND	11	46	GND
A6	12	45	B6
A7	13	44	B7
A8	14	43	B8
A9	15	42	B9
A10	16	41	B10
A11	17	40	B11
GND	18	39	GND
A12	19	38	B12
A13	20	37	B13
A14	21	36	B14
VCC	22	35	VCC
A15	23	34	B15
A16	24	33	B16
GND	25	32	GND
A17	26	31	B17
$\overline{\text{OEBA}}$	27	30	CLKBA
LEBA	28	29	GND

**56-PIN
V56
A56**

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	–65°C to +150°C
Ambient Temperature with Power Applied	–40°C to +85°C
Supply Voltage to Ground Potential (Inputs & V _{CC} Only)	–0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & D/O Only)	–0.5V to +7.0V
DC Input Voltage	–0.5V to +7.0V
DC Output Current	120mA
Power Dissipation	1.0W

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range, T_A = –40°C to +85°C, V_{CC} = 5.0V ± 10%)

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
V _{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level		2.0			V
V _{IL}	Input LOW Voltage	Guaranteed Logic LOW Level				0.8	V
I _{IH}	Input HIGH Current	Standard Input, V _{CC} = Max.	V _{IN} = V _{CC}			1	μA
I _{IH}	Input HIGH Current	Standard I/O, V _{CC} = Max.	V _{IN} = V _{CC}			1	μA
I _{IH}	Input HIGH Current	Bus Hold Input ⁽⁴⁾ , V _{CC} = Max.	V _{IN} = V _{CC}			±100	μA
I _{IH}	Input HIGH Current	Bus Hold I/O ⁽⁴⁾ , V _{CC} = Max.	V _{IN} = V _{CC}			±100	μA
I _{IL}	Input LOW Current	Standard Input, V _{CC} = Min.	V _{IN} = GND			–1	μA
I _{IL}	Input LOW Current	Standard I/O, V _{CC} = Min.	V _{IN} = GND			–1	μA
I _{IL}	Input LOW Current	Bus Hold Input ⁽⁴⁾ , V _{CC} = Min.	V _{IN} = GND			±100	μA
I _{IL}	Input LOW Current	Bus Hold I/O ⁽⁴⁾ , V _{CC} = Min.	V _{IN} = GND			±100	μA
I _{BHH}	Bus Hold	Bus Hold Input ⁽⁴⁾ , V _{CC} = Min.	V _{IN} = 2.0V	–50			μA
I _{BHL}	Sustain Current		V _{IN} = 0.8V	+50			μA
I _{OZH} ⁽⁵⁾	High-Impedance	V _{CC} = Max.	V _{OUT} = 2.7V			1	μA
I _{OZL} ⁽⁵⁾	Output Current (3-STATE OUTPUTS)	V _{CC} = Max.	V _{OUT} = 0.5V			–1	μA
V _{IK}	Clamp Diode Voltage	V _{CC} = Min., I _{IN} = –18 mA			–0.7	–1.2	V
I _{OS}	Short Circuit Current	V _{CC} = Max. ⁽³⁾ , V _{OUT} = GND		–80	–140	–200	mA
I _O	Output Drive Current	V _{CC} = Max. ⁽³⁾ , V _{OUT} = 2.5V		–50		–180	mA
V _H	Input Hysteresis				100		mV

Notes:

1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at V_{CC} = 5.0V, +25°C ambient and maximum loading.
3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
4. Pins with Bus Hold are identified in the pin description.
5. This specification does not apply to bi-directional functionalities with Bus Hold.

PI74FCT16501T Output Drive Characteristics (Over the Operating Range)

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
V _{OH}	Output HIGH Voltage	V _{CC} = Min., V _{IN} = V _{IH} or V _{IL}	I _{OH} = -3.0 mA	2.5	3.5		V
			I _{OH} = -15.0 mA	2.4	3.5		
			I _{OH} = -32.0 mA	2.0	3.0		
V _{OL}	Output LOW Voltage	V _{CC} = Min., V _{IN} = V _{IH} or V _{IL}	I _{OL} = 64 mA		0.2	0.55	V
I _{OFF}	Power Down Disable	V _{CC} = 0V, V _{IN} or V _{OUT} ≤ 4.5V		—	—	±100	μA

PI74FCT162501T/162H501T Output Drive Characteristics (Over the Operating Range)

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
V _{OH}	Output HIGH Voltage	V _{CC} = Min., V _{IN} = V _{IH} or V _{IL}	I _{OH} = -24.0 mA	2.4	3.3		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., V _{IN} = V _{IH} or V _{IL}	I _{OL} = 24 mA		0.3	0.55	V
I _{ODL}	Output LOW Current	V _{CC} = 5V, V _{IN} = V _{IH} OR V _{IL} , V _{OUT} = 1.5V ⁽³⁾		60	115	150	mA
I _{ODH}	Output HIGH Current	V _{CC} = 5V, V _{IN} = V _{IH} OR V _{IL} , V _{OUT} = 1.5V ⁽³⁾		-60	-115	-150	mA

Capacitance (T_A = 25°C, f = 1 MHz)

Parameters ⁽⁴⁾	Description	Test Conditions	Typ	Max.	Units
C _{IN}	Input Capacitance	V _{IN} = 0V	4.5	6	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V	5.5	8	pF

Notes:

1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at V_{CC} = 5.0V, +25°C ambient and maximum loading.
3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
4. This parameter is determined by device characterization but is not production tested.

Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
I _{CC}	Quiescent Power Supply Current	V _{CC} = Max.	V _{IN} = GND or V _{CC}		0.1	500	μA
ΔI _{CC}	Supply Current per Input @ TTL HIGH	V _{CC} = Max.	V _{IN} = 3.4V ⁽³⁾		0.5	1.5	mA
I _{CCD}	Supply Current per Input per MHz ⁽⁴⁾	V _{CC} = Max., Outputs Open OEAB = $\overline{\text{OEBA}}$ = V _{CC} or GND One Bit Toggling 50% Duty Cycle	V _{IN} = V _{CC} V _{IN} = GND		75	120	μA/ MHz
I _C	Total Power Supply Current ⁽⁶⁾	V _{CC} = Max., Outputs Open f _{CP} = 10 MHz (CLKAB) 50% Duty Cycle OEAB = $\overline{\text{OEBA}}$ = V _{CC} LEAB = GND One Bit Toggling fi = 5 MHz 50% Duty Cycle	V _{IN} = V _{CC} V _{IN} = GND		0.8	1.7 ⁽⁵⁾	mA
			V _{IN} = 3.4V V _{IN} = GND		1.3	4.2 ⁽⁵⁾	
		V _{CC} = Max., Output Open f _{CP} = 10 MHz (CLKAB) 50% Duty Cycle OEAB = $\overline{\text{OEBA}}$ = V _{CC} LEAB = GND Eighteen Bits Toggling fi = 2.5 MHz 50% Duty Cycle	V _{IN} = V _{CC} V _{IN} = GND		3.8	6.5 ⁽⁵⁾	
			V _{IN} = 3.4V V _{IN} = GND		8.5	20.8 ⁽⁵⁾	

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- Typical values are at V_{CC} = 5.0V, +25°C ambient.
- Per TTL driven input (V_{IN} = 3.4V); all other inputs at V_{CC} or GND.
- This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.
- I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}

$$I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_{CP}/2 + f_i N_i)$$

I_{CC} = Quiescent Current
ΔI_{CC} = Power Supply Current for a TTL High Input (V_{IN} = 3.4V)
D_H = Duty Cycle for TTL Inputs High
N_T = Number of TTL Inputs at D_H
I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)
f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)
f_i = Input Frequency
N_i = Number of Inputs at f_i
All currents are in milliamps and all frequencies are in megahertz.

PI74FCT16501T Switching Characteristics over Operating Range

Parameters	Description		Conditions ⁽¹⁾	16501AT		16501CT		16501DT		16501ET		Unit
				Com.		Com.		Com.		Com.		
				Min	Max	Min	Max	Min	Max	Min	Max	
t _{MAX}	CLKAB or CLKBA frequency		C _L = 50 pF R _L = 500Ω	—	150	—	150	—	150	—	150	MHz
t _{PLH} t _{PHL}	Propagation Delay A _x to B _x or A _x to B _x			1.5	5.1	1.5	4.6	1.5	4.1	1.5	3.8	ns
t _{PLH} t _{PHL}	Propagation Delay LEBA to A _x , LEAB to B _x			1.5	5.6	1.5	5.3	1.5	4.6	1.5	4.2	ns
t _{PLH} t _{PHL}	Propagation Delay CLKBA to A _x , CLKAB to B _x			1.5	5.6	1.5	5.3	1.5	4.6	1.5	4.2	ns
t _{PZH} t _{PZL}	Output Enable Time OEBA to A _x , OEAB to B _x			1.5	6.0	1.5	5.6	1.5	5.2	1.5	4.8	ns
t _{PHZ} t _{PLZ}	Output Disable Time ⁽³⁾ OEBA to A _x , OEAB to B _x			1.5	5.6	1.5	5.2	1.5	5.2	1.5	5.2	ns
t _{SU}	Setup Time HIGH or LOW A _x to CLKAB, B _x to CLKBA			3.0	—	3.0	—	3.0	—	2.4	—	ns
t _H	Hold Time HIGH or LOW A _x to CLKAB, B _x to CLKBA			0	—	0	—	0	—	0	—	ns
t _{SU}	Setup Time HIGH or LOW A _x to LEAB, B _x to LEBA	Clock HIGH		3.0	—	3.0	—	3.0	—	2.0	—	ns
		Clock LOW		1.5	—	1.5	—	1.5	—	1.5	—	ns
t _H	Hold Time HIGH or LOW A _x to LEAB, B _x to LEBA		1.5	—	1.5	—	1.5	—	0.5	—	ns	
t _w	LEAB or LEBA Pulse Width HIGH ⁽³⁾		3.0	—	3.0	—	3.0	—	3.0	—	ns	
t _w	CLKAB or CLKBA Pulse Width HIGH or LOW ⁽³⁾		3.0	—	3.0	—	3.0	—	3.0	—	ns	
t _{SK(o)}	Output Skew ⁽⁴⁾		—	0.5	—	0.5	—	0.5	—	0.5	ns	

Notes:

1. See test circuit and wave forms.
2. Minimum limits are guaranteed but not tested on Propagation Delays.
3. This parameter is guaranteed but not production tested.
4. Skew between any two outputs, of the same package, switching in the same direction. This parameter is guaranteed by design.

PI74FCT162501T Switching Characteristics over Operating Range

Parameters	Description		Conditions ⁽¹⁾	162501AT		162501CT		162501DT		162501ET		Unit
				Com.		Com.		Com.		Com.		
				Min	Max	Min	Max	Min	Max	Min	Max	
tMAX	CLKAB or CLKBA frequency		CL = 50 pF RL = 500Ω	—	150	—	150	—	150	—	150	MHz
tplh tphl	Propagation Delay Ax to Bx or Ax to Bx			1.5	5.1	1.5	4.6	1.5	4.1	1.5	3.8	ns
tplh tphl	Propagation Delay LEBA to Ax, LEAB to Bx			1.5	5.6	1.5	5.3	1.5	4.6	1.5	4.2	ns
tplh tphl	Propagation Delay CLKBA to Ax, CLKAB to Bx			1.5	5.6	1.5	5.3	1.5	4.6	1.5	4.2	ns
tpzh tpzl	Output Enable Time OEBA to Ax, OEAB to Bx			1.5	6.0	1.5	5.6	1.5	5.2	1.5	4.8	ns
tphz tplz	Output Disable Time ⁽³⁾ OEBA to Ax, OEAB to Bx			1.5	5.6	1.5	5.2	1.5	5.2	1.5	5.2	ns
tsu	Setup Time HIGH or LOW Ax to CLKAB, Bx to CLKBA			3.0	—	3.0	—	3.0	—	2.4	—	ns
th	Hold Time HIGH or LOW Ax to CLKAB, Bx to CLKBA			0	—	0	—	0	—	0	—	ns
tsu	Setup Time HIGH or LOW Ax to LEAB, Bx to LEBA	Clock HIGH		3.0	—	3.0	—	3.0	—	2.0	—	ns
		Clock LOW		1.5	—	1.5	—	1.5	—	1.5	—	ns
th	Hold Time HIGH or LOW Ax to LEAB, Bx to LEBA			1.5	—	1.5	—	1.5	—	0.5	—	ns
tw	LEAB or LEBA Pulse Width HIGH ⁽³⁾			3.0	—	3.0	—	3.0	—	3.0	—	ns
tw	CLKAB or CLKBA Pulse Width HIGH or LOW ⁽³⁾		3.0	—	3.0	—	3.0	—	3.0	—	ns	
tsk(o)	Output Skew ⁽⁴⁾		—	0.5	—	0.5	—	0.5	—	0.5	ns	

Notes:

1. See test circuit and wave forms.
2. Minimum limits are guaranteed but not tested on Propagation Delays.
3. This parameter is guaranteed but not production tested.
4. Skew between any two outputs, of the same package, switching in the same direction. This parameter is guaranteed by design.

PI74FCT162H501T Switching Characteristics over Operating Range (Advance Information)

Parameters	Description		Conditions ⁽¹⁾	162H501AT		162H501CT		162H501DT		162H501ET		Unit
				Com.		Com.		Com.		Com.		
				Min	Max	Min	Max	Min	Max	Min	Max	
tMAX	CLKAB or CLKBA frequency		CL = 50 pF RL = 500Ω	—	150	—	150	—	150	—	150	MHz
tplh tphl	Propagation Delay Ax to Bx or Ax to Bx			1.5	5.1	1.5	4.6	1.5	4.1	1.5	3.8	ns
tplh tphl	Propagation Delay LEBA to Ax, LEAB to Bx			1.5	5.6	1.5	5.3	1.5	4.6	1.5	4.2	ns
tplh tphl	Propagation Delay CLKBA to Ax, CLKAB to Bx			1.5	5.6	1.5	5.3	1.5	4.6	1.5	4.2	ns
tpzh tpzl	Output Enable Time OEBA to Ax, OEAB to Bx			1.5	6.0	1.5	5.6	1.5	5.2	1.5	4.8	ns
tphz tplz	Output Disable Time ⁽³⁾ OEBA to Ax, OEAB to Bx			1.5	5.6	1.5	5.2	1.5	5.2	1.5	5.2	ns
tsu	Setup Time HIGH or LOW Ax to CLKAB, Bx to CLKBA			3.0	—	3.0	—	3.0	—	2.4	—	ns
th	Hold Time HIGH or LOW Ax to CLKAB, Bx to CLKBA			0	—	0	—	0	—	0	—	ns
tsu	Setup Time HIGH or LOW Ax to LEAB, Bx to LEBA	Clock HIGH		3.0	—	3.0	—	3.0	—	2.0	—	ns
		Clock LOW		1.5	—	1.5	—	1.5	—	1.5	—	ns
th	Hold Time HIGH or LOW Ax to LEAB, Bx to LEBA			1.5	—	1.5	—	1.5	—	0.5	—	ns
tw	LEAB or LEBA Pulse Width HIGH ⁽³⁾			3.0	—	3.0	—	3.0	—	3.0	—	ns
tw	CLKAB or CLKBA Pulse Width HIGH or LOW ⁽³⁾		3.0	—	3.0	—	3.0	—	3.0	—	ns	
tsk(o)	Output Skew ⁽⁴⁾		—	0.5	—	0.5	—	0.5	—	0.5	ns	

Notes:

1. See test circuit and wave forms.
2. Minimum limits are guaranteed but not tested on Propagation Delays.
3. This parameter is guaranteed but not production tested.
4. Skew between any two outputs, of the same package, switching in the same direction. This parameter is guaranteed by design.